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April 1st, 2010 Renesas Electronics Corporation

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SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The μ PA1730 is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

FEATURES

• Low on-resistance

RDS(on)1 = $9.5 \text{ m}\Omega$ MAX. (Vgs = -10 V, ID = -6.5 A)

 $R_{DS(on)2}$ = 13.5 m Ω MAX. (Vgs = -4.5 V, ID = -6.5 A)

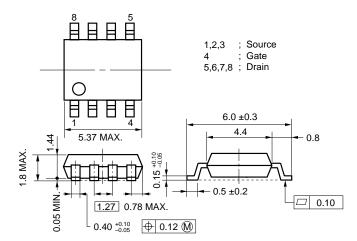
RDS(on)3 = 15.0 m Ω MAX. (VGS = -4.0 V, ID = -6.5 A)

- Low Ciss : Ciss = 3800 pF TYP.
- · Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1730G	Power SOP8

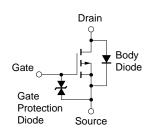
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-30	V
Gate to Source Voltage (VDS = 0 V)	Vgss	∓ 20	V
Drain Current (DC)	ID(DC)	∓ 13.0	Α
Drain Current (pulse) Note1	ID(pulse)	∓52.0	Α
Total Power Dissipation (T _A = 25°C) Note2	Рт	2.2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

EQUIVALENT CIRCUIT



Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Mounted on ceramic substrate of 1200 mm² x 2.2 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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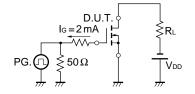
ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -10 \text{ V}, I_{D} = -6.5 \text{ A}$		7.6	9.5	mΩ
	RDS(on)2	$V_{GS} = -4.5 \text{ V}, I_{D} = -6.5 \text{ A}$		10.3	13.5	mΩ
	RDS(on)3	Vgs = -4.0 V, Ib = -6.5 A		11.3	15.0	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-1.0	-1.6	-2.5	V
Forward Transfer Admittance	y _{fs}	$V_{DS} = -10 \text{ V}, I_{D} = -6.5 \text{ A}$	11.0	23.0		S
Drain Leakage Current	IDSS	V _{DS} = -30 V, V _{GS} = 0 V			-1	μΑ
Gate to Source Leakage Current	Igss	$V_{GS} = \mp 20 \text{ V}, V_{DS} = 0 \text{ V}$			∓ 10	μΑ
Input Capacitance	Ciss	V _{DS} = -10 V		3800		pF
Output Capacitance	Coss	V _G S = 0 V		1200		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		500		pF
Turn-on Delay Time	td(on)	ID = -6.5 A		40		ns
Rise Time	tr	$V_{GS(on)} = -10 \text{ V}$		240		ns
Turn-off Delay Time	t _{d(off)}	V _{DD} = -15 V		230		ns
Fall Time	t f	$R_G = 10 \Omega$		160		ns
Total Gate Charge	Q _G	I _D = -13.0 A		70		nC
Gate to Source Charge	Qgs	$V_{DD} = -24 \text{ V}$		9		nC
Gate to Drain Charge	Q _{GD}	V _G S = −10 V		17		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 13 A, VGS = 0 V		0.80		V
Reverse Recovery Time	trr	IF = 13 A, VGS = 0 V		53		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs	_	57		nC

TEST CIRCUIT 1 SWITCHING TIME

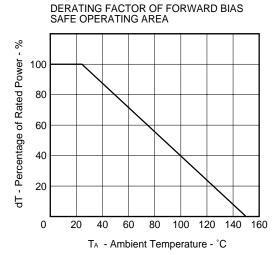
$PG. \bigcap_{RG} R_{G} = 10 \Omega$ $V_{GS} \bigvee_{Wave Form} \bigvee_{0} \underbrace{V_{GS} \bigvee_{V_{GS} (on)} 90 \%}_{Wave Form}$ $V_{GS} \bigvee_{Wave Form} 0 \underbrace{10 \%}_{V_{GS} (on)} \underbrace{10 \%}_{$

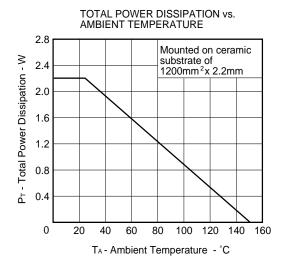
TEST CIRCUIT 2 GATE CHARGE



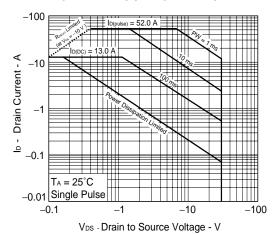


TYPICAL CHARACTERISTICS (TA = 25 °C)



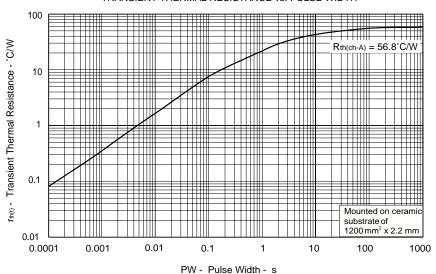


★ FORWARD BIAS SAFE OPERATING AREA

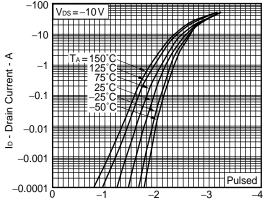


Remark Mounted on ceramic substrate of 1200 mm² x 2.2 mm

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

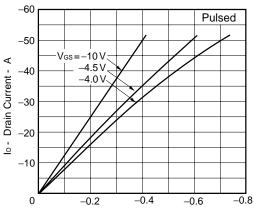


FORWARD TRANSFER CHARACTERISTICS



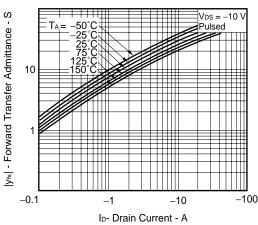
Vgs - Gate to Source Voltage - V

DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

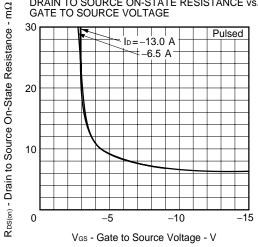


V_{DS} - Drain to Source Voltage - V

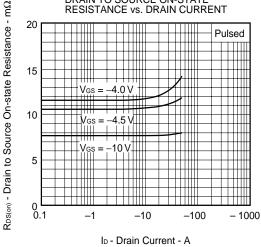
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



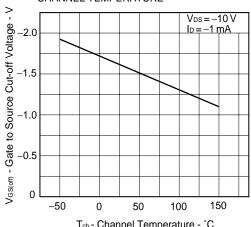
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



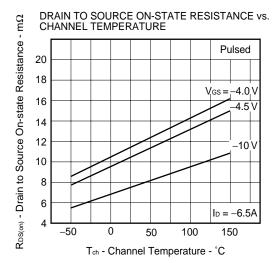
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

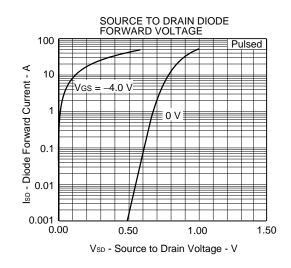


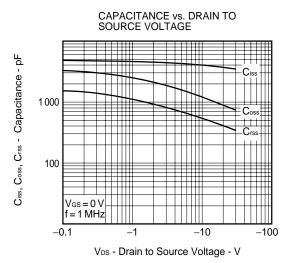
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

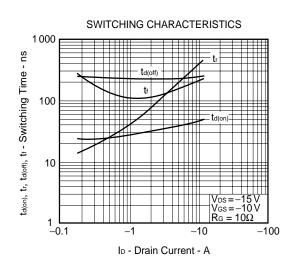


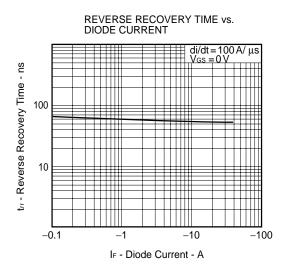
Tch - Channel Temperature - °C

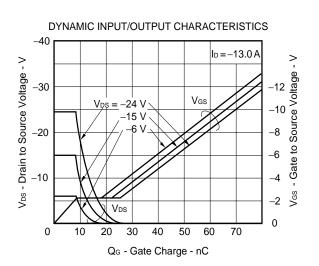












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